



45V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(on) max}	I _D T _A = 25°C
45)/	$46m\Omega @ V_{GS} = 10V$	4.8A
45V	62mΩ @ V _{GS} = 4.5V	4.1A

Description and Applications

This new generation MOSFET has been designed to minimize the onstate resistance ($R_{DS(on)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

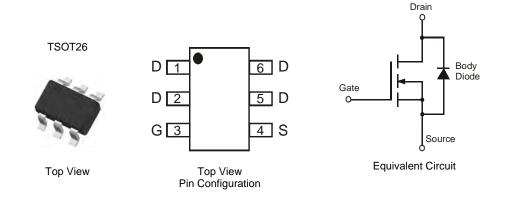
- DC-DC Converters
- Power management functions
- Backlighting

Features and Benefits

- Low Input Capacitance
- Low On-Resistance
- Fast Switching Speed
- Lead, Halogen, and Antimony Free, RoHS Compliant (Note 1)
- "Green" Device (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: TSOT26
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Tin Finish annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.013 grams (approximate)



Ordering Information (Note 3)

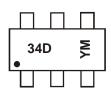
Part Number	Case	Packaging
DMN4060SVT-7	TSOT26	3,000/Tape & Reel

Notes: 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. No purposely added lead. Halogen and Antimony free.

2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com.

3. For packaging details, go to our website at http://www.diodes.com.

Marking Information



34D = Product Type Marking Code YM = Date Code Marking Y = Year (ex: Z = 2012) M = Month (ex: 9 = September)

Date Code Key

Date Code Rey													
Year	201	1	2012		2013 2014)14	2015		2016	2	2017	
Code	Y		Z		А	l	В	С		D		E	
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec	
Code	1	2	3	4	5	6	7	8	9	0	N	D	

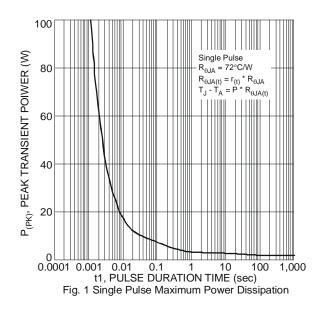


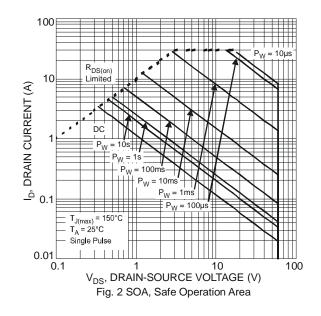
Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Units		
Drain-Source Voltage	V _{DSS}	45	V		
Gate-Source Voltage	V _{GSS}	±20	V		
	Steady State	$T_A = 25^{\circ}C$ $T_A = 70^{\circ}C$	I _D	4.8 3.8	А
Continuous Drain Current (Note 5) $V_{GS} = 10V$	t<10s	T _A = 25°C T _A = 70°C	I _D	6.1 4.8	А
	Steady State	T _A = 25°C T _A = 70°C	ID	4.1 3.2	А
Continuous Drain Current (Note 5) $V_{GS} = 5V$	t<10s	$T_A = 25^{\circ}C$ $T_A = 70^{\circ}C$	ID	5.2 4.1	А
Maximum Body Diode Forward Current (Note 5)	I _S	2.1	А		
Pulsed Drain Current (10µs pulse, duty cycle = 1%)	I _{DM}	30	А		
Avalanche Current (Note 6) L = 0.1mH	I _{AR}	14.2	А		
Avalanche Energy (Note 6) L = 0.1mH	E _{AR}	10	mJ		

Thermal Characteristics $@T_A = 25^{\circ}C$ unless otherwise specified

Characteristic		Symbol	Value	Units	
Total Dower Dissinction (Note 4)	T _A = 25°C	P	1.2	W	
Total Power Dissipation (Note 4)	$T_A = 70^{\circ}C$	PD	0.75	vv	
Thermal Desistance Junction to Ambient (Note 4)	Steady state	D	106	°C/W	
Thermal Resistance, Junction to Ambient (Note 4)	t<10s	$R_{ ext{ heta}JA}$	69	°C/W	
Total Power Dissipation (Note 5)	$T_A = 25^{\circ}C$	Р	1.8	W	
Total Power Dissipation (Note 5)	T _A = 70°C	PD	1.1		
Thermal Resistance, Junction to Ambient (Note 5)	Steady state	D	68	°C/W	
Thermal Resistance, Junction to Ambient (Note 5)	t<10s	$R_{ ext{ heta}JA}$	44	°C/W	
Thermal Resistance, Junction to Case (Note 5)		$R_{ ext{ heta}JC}$	20	°C/W	
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C	







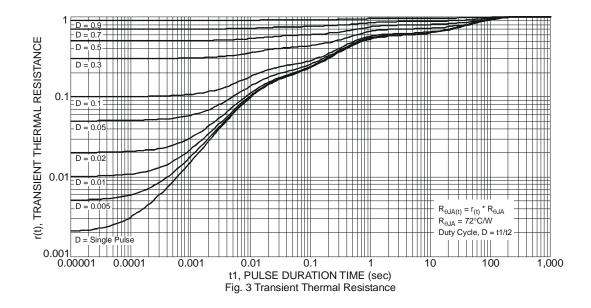
Electrical Characteristics @T_A = 25°C unless otherwise specified

<u>.</u>			_				
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)			i	i	i	+	
Drain-Source Breakdown Voltage	BV _{DSS}	45	—	—	V	$V_{GS} = 0V, I_D = 250 \mu A$	
Zero Gate Voltage Drain Current	IDSS			100	nA	$V_{DS} = 45V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}		—	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(th)}	1	_	3	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Static Drain-Source On-Resistance	D	_	37	46		$V_{GS} = 10V, I_D = 4.3A$	
Static Drain-Source On-Resistance	R _{DS (ON)}		52	62	mΩ	$V_{GS} = 4.5V, I_D = 4A$	
Forward Transfer Admittance	Y _{fs}		4.5		S	$V_{DS} = 10V, I_D = 4.3A$	
Diode Forward Voltage	V _{SD}		0.7	1.2	V	$V_{GS} = 0V, I_{S} = 1A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_	1287				
Output Capacitance	Coss	_	57		pF	V _{DS} = 25V, V _{GS} = 0V f = 1.0MHz	
Reverse Transfer Capacitance	Crss	_	44	_			
Gate Resistance	R _G		1.2	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge (V _{GS} = 10V)	Qg		22.4	_			
Total Gate Charge ($V_{GS} = 4.5V$)	Qg		10.4	_	nC	V 20V L 4 24	
Gate-Source Charge	Q _{gs}		4.9	_	nc	$V_{DS} = 30V, I_D = 4.3A$	
Gate-Drain Charge	Q _{gd}		3.0	_			
Turn-On Delay Time	t _{D(on)}	_	6.6				
Turn-On Rise Time	tr	_	8.1		nS	$V_{GS} = 10V, V_{DD} = 30V, R_G = 6\Omega,$	
Turn-Off Delay Time	t _{D(off)}	_	20.1	_	15	$I_D = 4.3A$	
Turn-Off Fall Time	tf	_	4.0				
Body Diode Reverse Recovery Time	t _{rr}		18		nS	I _S = 4.3A, dI/dt = 100A/µs	
Body Diode Reverse Recovery Charge	Q _{rr}		11.9		nC	I _S = 4.3A, dI/dt = 100A/µs	

4. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout. Notes:

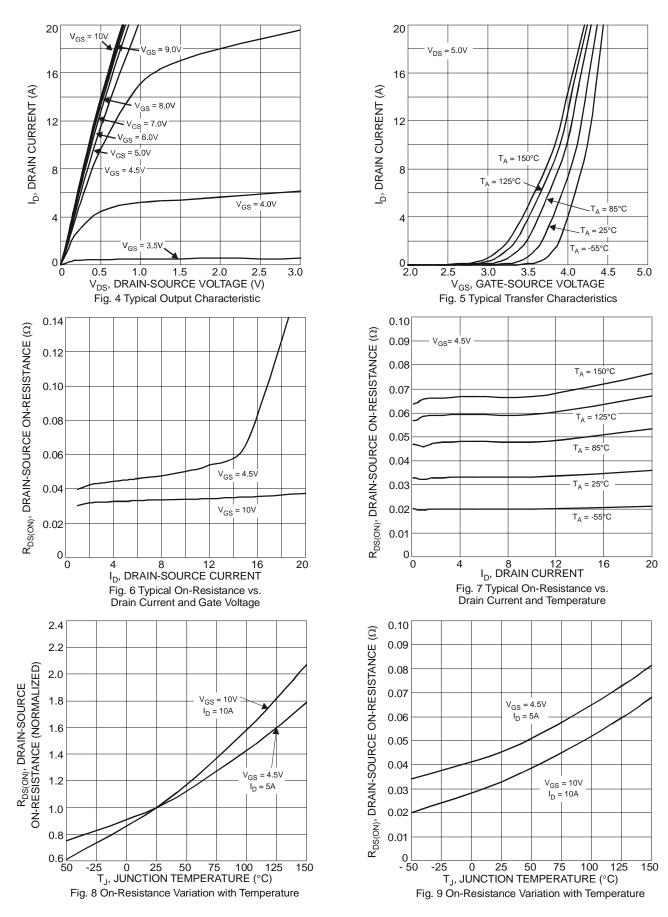
5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

6. I_{AR} and E_{AR} rating are based on low frequency and duty cycles to keep $T_J = 25^{\circ}C$ 7. Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing.

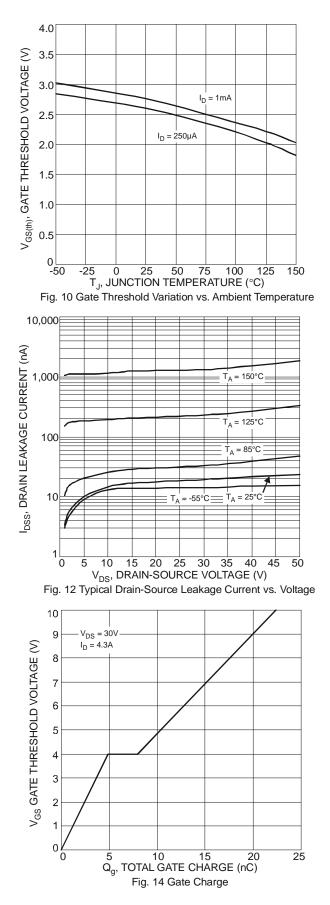


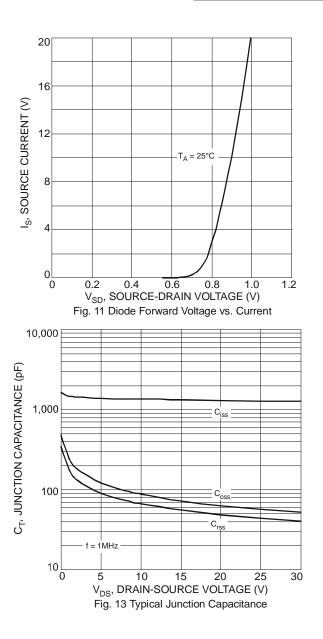
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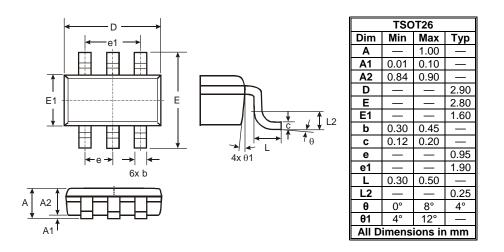




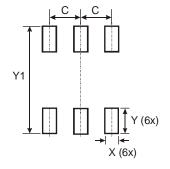




Package Outline Dimensions



Suggested Pad Layout



Dimensions	Value (in mm)
С	0.950
Х	0.700
Y	1.000
Y1	3.199



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